

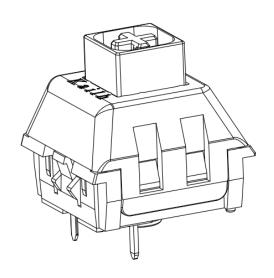


## **Document Number:**

KH-PS1706-35

# 产品规格书

Product Specification



Pale Blue shaft 浅蓝轴

P/N:			Title:		
CPG1511F01S06			PG15	11F Keyboard	d Switch
Rev.	ECN	Release and Revision Description:	Prepared By /Date:	Checked By/Date:	Approved By/Date:
A		New releasing 初版发行	张林/2017.06.15	易平/2017.06.15	王锋/2017.06.15



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### 1. Scope/范围:

This Product Specification covers the requirement of Mechanical Keyboard switch on product performance, test methods and quality assurance provisions.

本规格书内容涵盖机械键盘开关产品的要求,包括性能指标、测试方法及质量保证方面等。

### 2. Product Application/产品应用:

Mainly applied on computer keyboards, cash registers, industrial equipment and Man-Machine interface.

主要适用于电脑键盘, 收银机、工业设备和人机界面。

### 3. Technology Parameters/技术参数

Ambient Humidity 工作湿度: 45~85% R.H.;

Operating Temperature Range 使用温度范围: -10℃~+70℃; Storage Temperature Range 保存温度范围: -20℃~+70℃;

Suggested storage period 贮存期限: about 6 months 最多 6 个月

Require the tin part on the switch terminals should keep good after storage guarantee date 要求贮存期后开关端子部分上锡仍然良好。

Normal Condition:

Ambient temperature 环境温度: 20±2℃

Relative humidity 相对湿度: 65%±5% R.H.; Air pressure 气压: 86~101KPa;

#### 4. Ratings/额定性能要求

Rating 额定负荷:

Insulation Resistance 绝缘电阻:

Withstand Voltage 耐电压:

Mechanical Life 机械寿命:

5. Profile Dimensions /外形尺寸

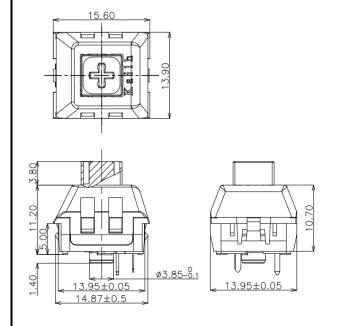
12V AC/DC max. 2V DC min.

10mA AC/DC max. 10 µ A DC min:

 $\geq$ 100M $\Omega$ /DC 100V;

100 AC 1 Minute;

80,000,000 Cycles (Without Load).





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### 6. Electrical Performance/电气性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
6.1	Contact Resistance 接触电阻	Static load: (Operation force)x2, which is applied on the center of Switch stem. 静态负载: 动作力的 2 倍,施加在手柄中心.  Measurement tool: Contact resistance Meter. 测量工具: 微电流接触电阻计(1KHz, 20mV,5~50mA)  在低电流(≤100mA)条件下测试.  Measured at low current (100mA or less).	200mΩ Max 200mΩ以下
Insulation 6.2 Resistance 绝缘电阻		Apply a Voltage of DC 100 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 100V DC 电压 1 分钟,按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	100MΩ Min 100 兆欧以上
Dielectric withstanding voltage 耐电压		Apply a Voltage of AC100 V (50~60Hz) for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 100V AC 电压 1 分钟, 按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	No evidence of breakdown 无瞬断、击穿等破坏.
6.4	Bouncing 触点抖动	Operation speed: 3~4 times/s 操作速度: 每秒 3~4 次 Oscillo scope 示波器 Switch Bouncing Test Circuit 抖动测定回路.	Before Life cycle: On:5ms MAX,5 毫秒以下 Off: 5ms MAX,5 毫秒以下 After Life cycle: On:10ms MAX,10 毫秒以下 Off: 10ms MAX,10 毫秒以下



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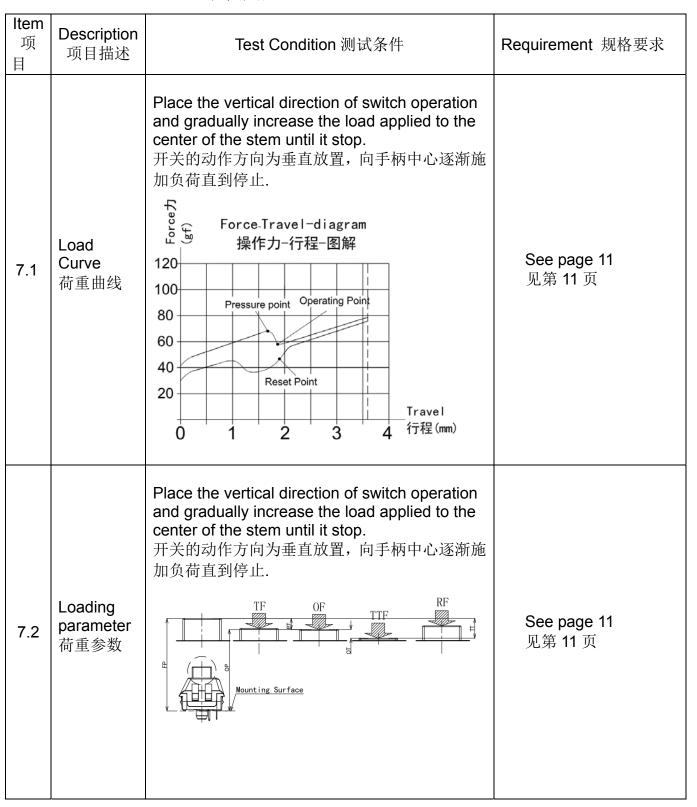
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### 7. Mechanical Performance/机械性能





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7.3	Static Strength 静止强度	A static load of 3kgf shall be applied in the direction of button operation for a period of 60 seconds. 在手柄动作方向施加 3kgf 的静负荷 60 秒, 然后测试参数.	No damage (Electrical) And mechanical) 电气和机械性能正常.
7.4	Stem Pull Strength 手柄拉拔强 度	Break by a pull force applied opposite to the direction of stem operation. 在推柄动作方向反向垂直施加拉力, 使其破坏的程度.	5kgf Min
7.5	Shock 机械冲击	Measured by according to the below condition:  (1) Acceleration: 80g 加速度  (2) Cycles of test:3 cycles each in 6 directions, for a total of 18 cycles. 试验次数: 每个方向 3 次,6 个方向共 18 次.	Shall meet No.6,7.1,7.2. 满足 6,7.1,7.2 要求.
7.6	Life Test 寿命测试	1) D.C.12V 10mA resistance load D.C 12V 10mA 电阻负荷 2) Operation speed: 5-6 times / s 动作速度: 5-6 次/ 秒 3) Push force: 150gf 按力: 150gf 5) Push travel: 3.6mm 按压行程: 3.6mm 6) Operation number: 80,000,000cycles 动作次数: 80,000,000 次	Contact resistance: 1Ω Max 接触电阻: 1 欧以下 Bouncing: 10ms Max 触点抖动: 10 毫秒以下 Operation force: Variation rate within ± 30% 操作力的变化范围在初始 值的±30%以内.



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### 8. Environmental Performance/环境性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
8.1	8.1 Cold test 耐寒性  (1) Temperature: - 20±2℃ 温度: - 20±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时		Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2
8.2	Heat test 耐热性	(1) Temperature: 70±2℃ 温度: 70±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时	Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2
8.3	Temperature cycle 温度循环	(1) Test cycles: 5 cycles 试验周期: 5 个周期 (2) Standard condition after test:1h 试验后的放置条件: 1 小时  Temperature 温度 Duration of test 持续时间  1 cycle 20±5℃ 1h  -次循环 -20±5℃ 1h  20±5℃ 1h  70±5℃ 1h	Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2
8.4	Soldering heat test 耐焊接热	Soldering area: T/2 of PWB thickness. (PWB: T=1.6mm) 焊接面积: 印刷基板的 1/2 厚度处 Soldering temperature: 260±5℃ Soldering time: 3±0.5s 焊接温度: 260±5℃ 焊接时间: 3±0.5 秒	Appearance: No abnormality. 外观无异常



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8.5	Solder ability 可焊性	1. Hand soldering 手工焊接: Please practice according to below condition: (1) Soldering Temperature: 350±5℃ 焊接温度: 350±5℃ (2) Continual soldering time: 3±0.5s 连续焊接时间: 3±0.5秒 (1) Capacity of soldering iron: ≤20w 电烙铁功率: 20 瓦以下 2. Automatic PIP soldering 自动插板焊接: For the product of T/H according to below condition:  波峰焊温度曲线图(单波峰)	At least 95% of surface area of immersed portion shall be covered by solder. 浸焊面积大于 90%以上.
8.6	Humidity test 耐湿性	<ul> <li>(1) Temperature: 60±2℃ 温度: 60±2℃</li> <li>(2) relative humidity: 90~95% R.H. 相对湿度:90~95% R.H.</li> <li>(3) Duration of test: 48h 持续时间: 48 小时</li> <li>(4) Take off a drop water 去掉水珠</li> <li>(5) Standard conditions after test: 1h 试验后的放置条件: 1 小时</li> </ul>	Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2
8.7	Salt Spray 盐雾测试	Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盐水浓度: 5±1%; (3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be removed by running water. 实验后将盐沉积物用水冲掉	Appearance: No corrosion spot, no crack, no base plate naked. 外观: 无腐蚀点, 无裂纹, 无裸露基材.  Contact Resistance: 200 m Ω Max 接触电阻: 200 毫欧以下



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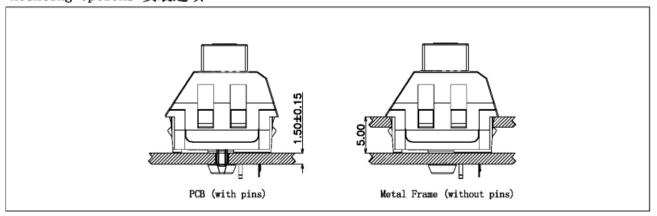
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8.8	Protection Against ingress of dust(IP5X) 防尘	The switches are planormal use inside the The test is carried or second enclosure of The test shall be coresh.  测试样品以正常使用按IEC60529或GBA进行试验;试验应持续8小时;	e test chamber. ut according to the IEC60529/GB420 ntinued for a period 位置在防尘箱中安	; )8. d of :装;	Between terminal at the crust Dielectric voltage ≥ 动作正常 端子之间	g is norma terminals and surface withstand	te of d in 外壳
8.9	Protection against ingress water(IPX6) 防水	The switches are planormal use inside the The test is carried or second enclosure of 测试样品以正常使用按 IEC60529 或 GB4进行试验;	e test table. ut according to the IEC60529/GB420 位置在防尘箱中安	; )8. ·装;	Water do electric p switch in Between terminal a the crust Dielectric voltage ≥ 动水部分	g is norma n't enter arts of the side. terminals and surfac withstand	e of d in 带电

### 9. Recommended PCB Layout 推荐的 PCB 安装焊盘规格

Mounting Options 安装选项





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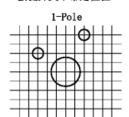
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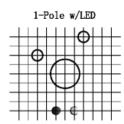
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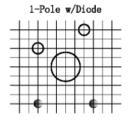
Circuit Board Layouts 电路板布局

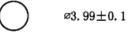
Grid line spacing = 1.27mm 网格线间距= 1.27毫米

Keyswitch without fixation pins 按键开关不带定位柱





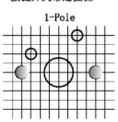


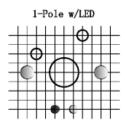


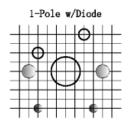
O Ø1.50±0.05

● Ø1.0±0.1

Keyswitch with fixation pins 按键开关带定位柱









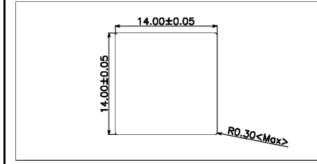
 $\emptyset 3.99 \pm 0.1$ 

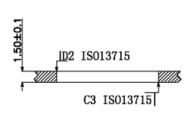
Ø1. 70±0. 05

Ø1. 50±0. 05

© Ø1.0±0.1

Metal Frame Cutout Dimensions





### 10. Loading Parameter (TT/PT/OT /OF/TF/RF) Specification 荷重参数规格:

Parameter	Unit	Specification	Remark
TT(总行程)	mm	$3.60 \pm 0.3$	
PT(导通行程)	mm	$1.80 \pm 0.3$	
OT(过行程)	mm	1.30	Min.
OF(动作力)	gf	60±15	
TF(触感力)	gf	70±10	
RF(回弹力)	gf	15	Min.

#### 11. Packaging 包装

Packaging type: Tray, 1000Pcs/Tray, 4000Pcs/Carton.

包装方式: Tray 盘,1000Pcs/盘,4000Pcs/箱.



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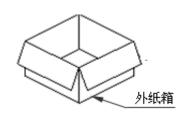
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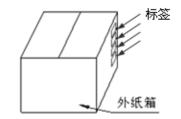
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#### 12.Precaution 注意事项

12.1 Immersion Soldering condition 浸焊条件

12.1 Infinersion Soldering Condition 仅序案件				
ITEM	CONDITION			
项目	条件			
Preheat temperature 预热温度	110℃ Max (Ambient temperature of soldering surface of P.W.B) 110℃以下(印刷基板焊锡面周围的温度)			
Preheat time 预热时间	60s, Max 60 秒以内			
Area of flux	1/2 Max of PWB Thickness			
助焊剂面积	印刷基板厚度的 1/2 以内			
Temperature of solder	260±5℃			
焊锡温度	260±5℃			
Time of immersion	3s±0.5s			
浸焊时间	$3s\pm0.5s$			
Number of soldering	2time Max (But should down heat of the first soldering)			
焊接次数	2 次以内			
Printed wiring board	Single side copper-clad laminates			
印刷基板	单面铜箔			

- (1) After switches were soldered, please be careful not to clean switches with solvent 开关浸焊后,注意不要用溶剂清洗.
- (2) Under the condition of using soldering iron, soldering temperature shall be 350℃±5℃ with 3±0.5s. 在使用铬铁的情况下,焊锡温度应在350℃±5℃, 焊接时间3±0.5秒.

#### 12.2 Notes 注意点

- (1) Please be cautious not to give excessive static load or shock to switches.
  - 注意不要施加超负荷的压力或晃动开关.
  - (2) Please be careful not to stack up P. W. B. after switches were soldered. 开关焊接以后,印刷基板注意不要叠放.
  - (3) Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton. 保管时尤其应注意避开高湿高温和有腐蚀性气体的环境.如需长时间保存,请不要打开包装箱.
  - (4) Products meet the ROHS & REACH environmental management substances control standards 产品满足 ROHS & REACH 环境管理物质管制标准